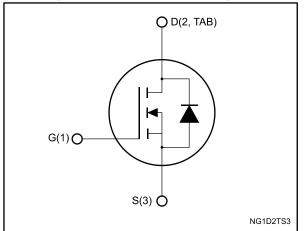


Datasheet - production data

# N-channel 80 V, 6.4 mΩ typ., 80 A, STripFET<sup>™</sup> F7 Power MOSFET in a TO-220 package

TAB TAB TO-220

Figure 1: Internal schematic diagram



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)max</sub>	ID	P <sub>TOT</sub>
STP110N8F7	80 V	7.5 mΩ	80 A	170 W

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness

### Applications

• Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

Order code	Marking	Package	Packaging
STP110N8F7	110N8F7	TO-220	Tube

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This is information on a product in full production.

#### Contents

### Contents

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# 1 Electrical ratings

Symbol	Parameter	Value	Unit	
V <sub>DS</sub>	Drain-source voltage	80	V	
$V_{GS}$	Gate-source voltage	±20	V	
I <sub>D</sub>	Drain current (continuous) at $T_C = 25 \text{ °C}$	80 <sup>(1)</sup>	А	
ID	Drain current (continuous) at T <sub>C</sub> = 100 °C	76	А	
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	А	
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	170	W	
E <sub>AS</sub> <sup>(3)</sup>	Single pulse avalanche energy 220		mJ	
TJ	Operating junction temperature	55 to 175	°C	
T <sub>stg</sub>	Storage temperature	-55 to 175		

#### Table 2: Absolute maximum ratings

#### Notes:

<sup>(1)</sup>Limited by package

<sup>(2)</sup>Pulse width is limited by safe operating area

 $^{(3)}Starting~T_{j}$  = 25°C,  $I_{d}$  = 25 A,  $V_{dd}$  = 40 V

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.88	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W



# 2 Electrical characteristics

(T<sub>c</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}=0,\ I_D=250\ \mu A$	80			V
	Zero gate voltage	$V_{GS} = 0, V_{DS} = 80 V$			1	μA
I <sub>DSS</sub>	drain current	$V_{GS} = 0, V_{DS} = 80 V,$ $T_{C} = 125 \ ^{\circ}C$			10	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 V$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$	2.5		4.5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$		6.4	7.5	mΩ

#### Table 4: On /off states

Table 5: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	3435	-	pF
Coss	Output capacitance	$V_{GS} = 0, V_{DS} = 40 V,$	-	653	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	f = 1 MHz	-	57	-	pF
Qg	Total gate charge	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 80 \text{ A},$	-	46.8	-	nC
$Q_gs$	Gate-source charge	$V_{GS} = 10 V$	-	23.4	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	11.2	-	nC

#### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 40 \text{ V}, I_D = 40 \text{ A},$	-	49	-	ns
tr	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	95	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13: "Test circuit for resistive load	-	60	-	ns
t <sub>f</sub>	Fall time	switching times" and Figure 18: "Switching time waveform")	-	32	-	ns



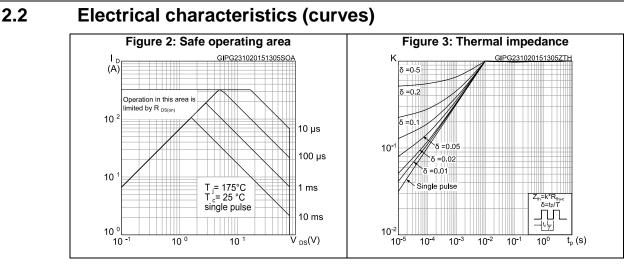
#### Electrical characteristics

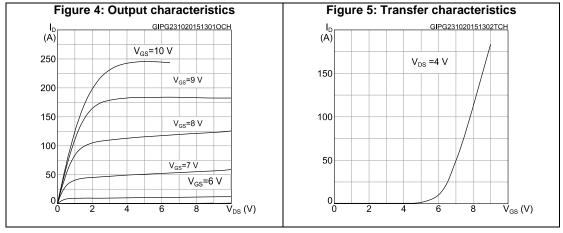
	Table 7: Source drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$V_{GS} = 0, I_{SD} = 80 \text{ A}$	-		1.2	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 80 A, di/dt = 100 A/µs	-	48.6		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ (see <i>Figure 15:</i>	-	58.6		nC
I <sub>RRM</sub>	Reverse recovery current	"Test circuit for inductive load switching and diode recovery times")	-	2.4		A

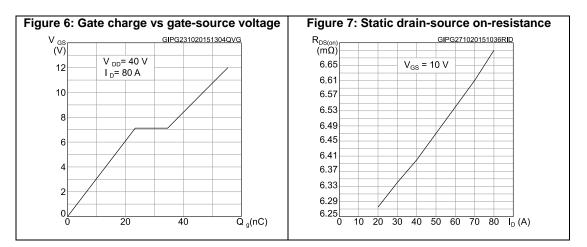
#### Notes:

 $^{(1)}$ Pulsed: pulse duration = 300  $\mu s,$  duty cycle 1.5%





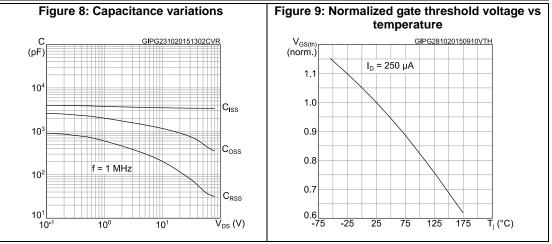


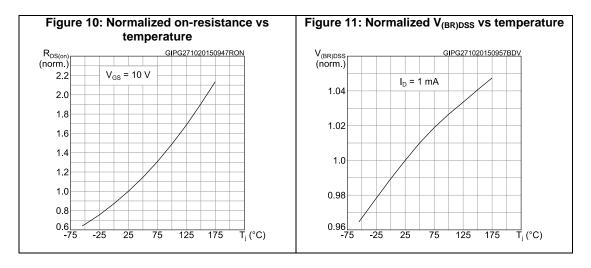


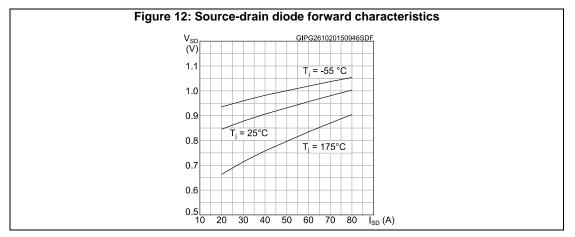
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#### **Electrical characteristics**

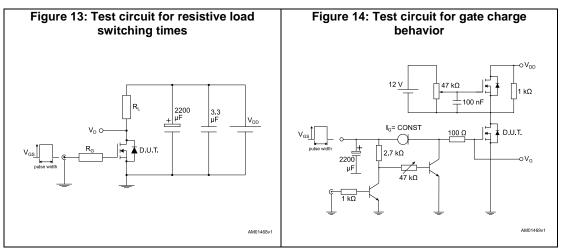


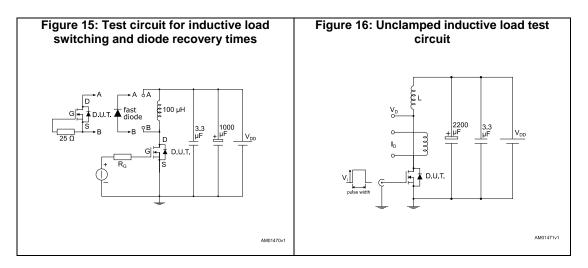


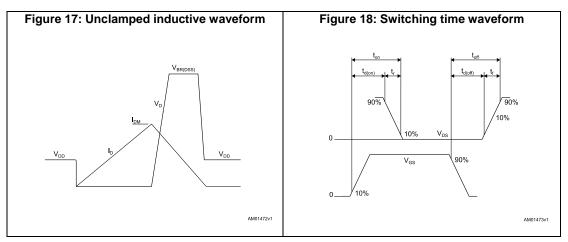


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### 3 Test circuits







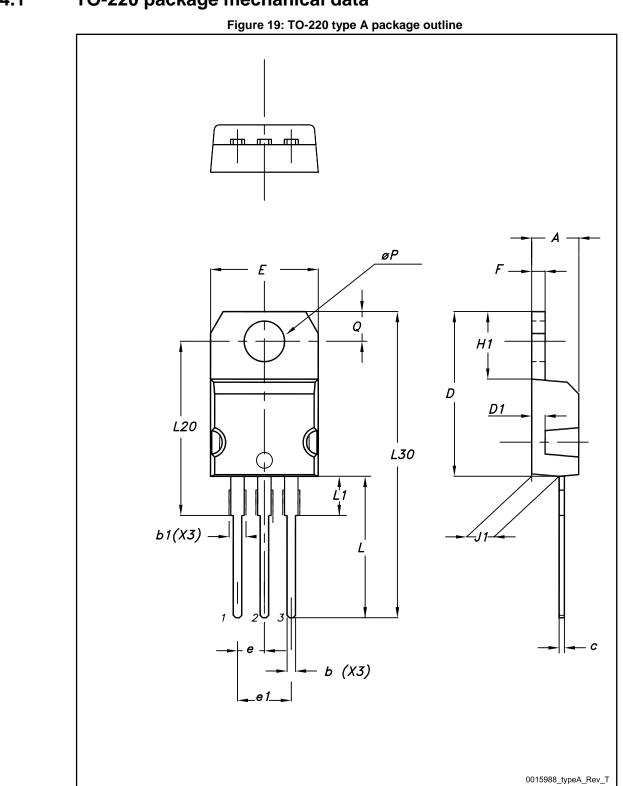
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### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.





### 4.1 TO-220 package mechanical data

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#### Package mechanical data

F7	Package mechanical data				
	Table 8: TO-220 typ	be A mechanical data			
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.70		
с	0.48		0.70		
D	15.25		15.75		
D1		1.27			
E	10		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13		14		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
øP	3.75		3.85		
Q	2.65		2.95		



#### **Revision history** 5

Table 9: Document revision history	Table 9:	Document	revision	history
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Date	Revision	Changes
10-Nov-2014	1	Initial release.
04-Nov-2015	2	Datasheet promoted from target to production data. Modified: Table 2: "Absolute maximum ratings", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source drain diode" Added: Section 4.1: "Electrical characteristics (curves)" Minor text changes.



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